

COMPOUND TRANSISTOR BA1F4Z

on-chip resistor NPN silicon epitaxial transistor For mid-speed switching

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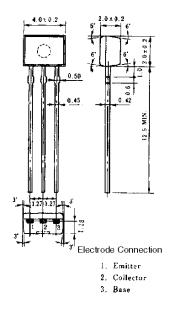
FEATURES

- On-chip bias resistor (R1 = 22 kΩ)
- Complementary transistor with BN1F4Z

Symbol	Ratings	Linit
		Unit
Vсво	60	V
VCEO	50	V
VEBO	5	V
IC(DC)	100	mA
IC(pulse) *	200	mA
Ρτ	250	mW
Tj	150	°C
Tstg	–55 to +150	°C
	VCEO VEBO IC(DC) IC(pulse) * PT Tj	VCEO 50 VEBO 5 IC(DC) 100 IC(pulse) * 200 PT 250 Tj 150 Tstg -55 to +150

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

PACKAGE DRAWING (UNIT: mm)



* PW \leq 10 ms, duty cycle \leq 50 %

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vсв = 50 V, IE = 0			100	nA
DC current gain	hfe1 **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 5.0 \text{ mA}$	135	330	600	-
DC current gain	hfe2 **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 50 \text{ mA}$	100	290		-
Collector saturation voltage	V _{CE(sat)} **	Ic = 5.0 mA, Iв = 0.25 mA		0.04	0.2	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$		0.55	0.5	V
High level input voltage	ViH **	$V_{CE} = 0.2 \text{ V}, \text{ Ic} = 5.0 \text{ mA}$	3.0	1.05		V
Input resistance	R1		15.4	22	28.6	kΩ
Turn-on time	ton	V_{CC} = 5.0 V, R_L = 1.0 k Ω			0.2	μs
Storage time	tstg	$V_{I} = 5.0 V, PW = 2.0 \mu s$			5.0	μs
Turn-off time	toff	duty cycle≤2 %			6.0	μs

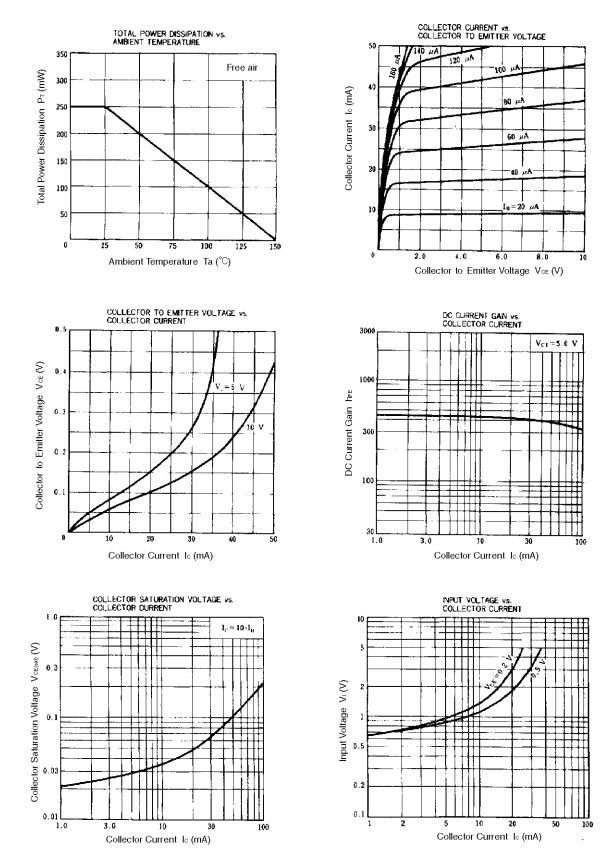
** Pulse test PW \leq 350 μ s, duty cycle \leq 2 %

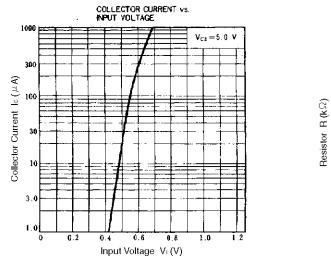
hfe CLASSIFICATION

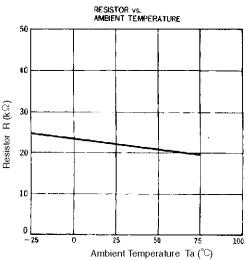
Marking	Q	Р	К
hfe1	135 to 270	200 to 400	300 to 600

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TYPICAL CHARACTERISTICS (Ta = 25°C)







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